

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of

Applicants : Werner Juengling et al.  
Serial No. : TBD  
Filed : February 3, 2004  
Title : FILL PATTERN GENERATION FOR SPIN-ON GLASS AND  
RELATED SELF-PLANARIZATION DEPOSITION  
Docket No. : MIO 0074 VA  
Examiner : W. Vesperman  
Art Unit : 2813

Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

OFFICIAL COMMUNICATION

This Official Communication is in regard to the divisional application filed herewith, which claims priority to currently pending Application Serial No. 10/032,877, filed October 24, 2001.

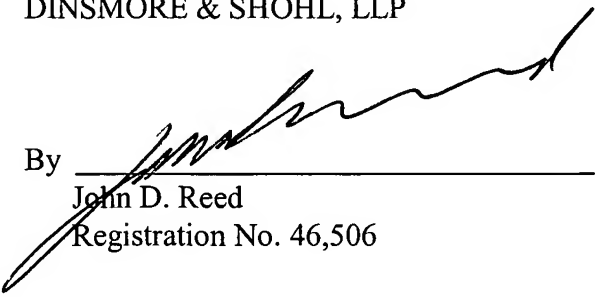
This divisional application is filed in the present case by filing a new specification with new claims, along with the oath or declaration from the prior (parent) application pursuant to 37 CFR §1.53(b). The text of the newly filed specification includes changes to the specification, abstract and drawings that were originally filed and prosecuted in the parent application from which this divisional application claims priority. The changes made thereto do not introduce new matter. Rather, the changes are presented to update the status of the application, including amendments made to the parent application, as well as to present claims that were not elected in the parent application in response to a telephone restriction requirement on September 11, 2003.

The Applicants respectfully submit that the claims of the present divisional application represent allowable subject matter. The Examiner is encouraged to contact the undersigned to

resolve efficiently any formal matters or to discuss any aspects of the application or of this Official Communication. Otherwise, early notification of allowable subject matter is respectfully solicited.

Respectfully submitted,  
DINSMORE & SHOHL, LLP

By

  
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John D. Reed

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